

5x5x1.1mmTops Power Pure Green &Red & Blue LED

OSTCXBSEC1E

VER.A.1

■Outline Dimension

■Features

- Highest Luminous Flux
- Super Energy Efficiency
- Long Lifetime Operation
- Superior UV Resistance
- Water Clear Type

■Applications

- Mobile Phone Flash
- Automotive Interior/Exterior Lighting / Signal Lighting
- Architectural Lighting

Item

DC Forward Current

Reverse Voltage

Power Dissipation

Pulse Forward Current*

Operating Temperature Storage Temperature

Lead Soldering Temperature

- LCD TV / Monitor Backlight
- Projector Light Source / Traffic Signals / Task Lighting
- Decorative / Pathway Lighting / Household Applications

Symbol

 I_{FP}

 V_R P_{D}

Topr

Tstg

Tsol

-40 ~ +100

260°C/10sec

Heat-sink Solder Red Anode 1,2,3.Cathode 4.5.6 Anode Recommended Solder Pad Design Unite: mm Tolerance:±0.20mm unless otherwise ntoed

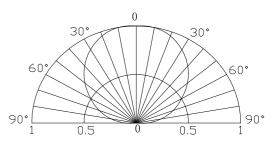
■Absolute Maximum Rating

Va	Unit		
Red	Green/Blue	Oilit	
200	200	mA	
250	250	mA	
5	5	V	
600	800	mW	
-30 ~	$^{\circ}\mathrm{C}$		

*Pulse width Max.10ms Duty ratio max 1/10

Directivity

 $^{\circ}$ C



■Electrical -Optical Characteristics (Ta=25℃)

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage	V _F (R)	I _F =150mA	2.0	2.5	3.0	V
	V _F (B/G)	I _F =150mA	3.0	3.3	4.0	V
DC Reverse Current	I_R	V _R =5V	1	1	10	μA
Domi. Wavelength	$\lambda_D(Red)$	I _F =150mA	620	625	630	nm
	$\lambda_D(Green)$	I _F =150mA	520	525	535	nm
	$\lambda_D(Blue)$	I _F =150mA	460	465	475	nm
Luminous Flux	Φv (Red)	I _F =150mA	15	20	-	lm
	Фv (Green)	I _F =150mA	20	30	-	lm
	Фv (Blue)	I _F =150mA	5	10	-	lm
50% Power Angle	2θ1/2	I _F =150mA	1	120	-	deg

^{*1} Tolerance of measurements of dominant wavelength is ±1nm

Note: Don't drive at rated current more than 5s without heat sink for Tops H Power emitter series.

LED & Application Technologies









VER A.1 http://www.optosupply.com

^{*2} Tolerance of measurements of luminous intensity is ±15%

^{*3} Tolerance of measurements of forward voltage is ±0.1V

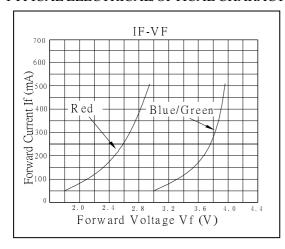


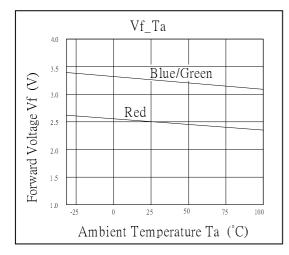
5x5x1.1mmTops Power Pure Green & Red & Blue LED

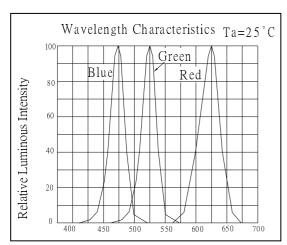
OSTCXBSEC1E VER.A.1

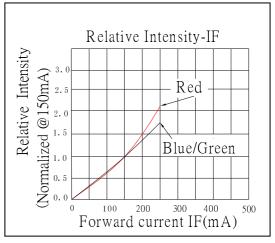
InGaN AND AlInGaP LED

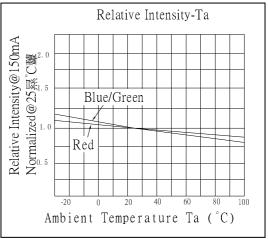
TYPICAL ELECTRICAL/OPTICAL CHARACTERISTIC CURVES

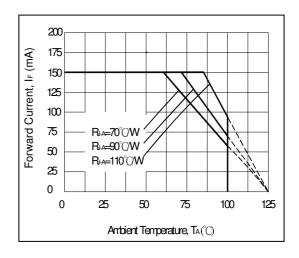












LED & Application Technologies











5x5x1.1mmTops Power Pure Green &Red & Blue LED

OSTCXBSEC1E VER.A.1

RELIABILITY TEST REPORT

CLASSIFICATION		TEST ITEM	TEST CONDTION	
ENDURANCE TEST			If: 150mA Ta:25±5 <u>°</u> TEST TIME=1000HRS	
	ГЕЅТ	HIGH TEMPERTURE HIGH HUMIDITY STORAGE	R.H:90~95% Ta:65±5°C TEST TIME=240HRS(+2HRS)	
		HIGH TEMPERTURE STORAGE	Ta:100°C TEST TIME=500HRS(-24HRS,+48HRS)	
		LOW TEMPERTURE STORAGE	Ta:-40°C TEST TIME=500HRS(-24HRS,+48HRS)	
ENVIRONMENTAL TEST		TEMPERTURE CYCLING	-40°C ~25°C ~100°C ~25°C 30min 5min 30min 5min 20cycles	
	TEST	RESISTANCE TO SOLDERING HEAT	Ta:260 \pm 5°C TEST TIME=10 \pm 1sec	
		SOLDERABILITY	Ta:245±5°C TEST TIME=5±1sec	

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

MEASURING ITME	SYMBOL	CONDITIONS	FAILURE CRITERIA
LUMINOUS INTENSITY	IV	IF=150mA	IV<0.5*L.S.L
FORWARD VOLTAGE	VF	IF=150mA	VF>1.2*U.S.L
REVERSE CURRENT	IR	Vr=5V	IR>2*U.S.L
SOLDERABILITY		-	LESS THAN 95% SOLDER
	-		COVERAGE

U.S.L: Upper Specification Limit L.S.L: Lower Specification Limit

LED & Application Technologies









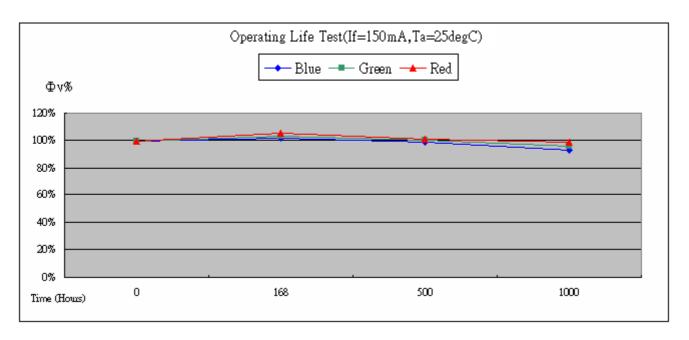
http://www.optosupply.com VER A.1

5x5x1.1mmTops Power Pure Green & Red & Blue LED

OSTCXBSEC1E

VER.A.1

OPERATION LIFE TEST LUMINANCE RATE CURVE



^{*}Burn-in condition: 150mA









^{*}Projection of Statistical Average Light Output Degradation Performance for LED Technology Extrapolated from OptoSupply QA Dept. Test Data.

^{*}According to OptoSupply outgoing Packaged Products Specification

^{*}MTBF:30,000hrs, 90% Confidence (A Failure is Any LED Which is Open, shorted or fails to Emit Light)

^{*}The Projected Data is Base on The Feature of LED Itself Under Normal Operation Conditions.

^{*}Any Improper Circuit Design or External Factors Might Cause a Different Result.



5x5x1.1mmTops Power Pure Green & Red & Blue LED

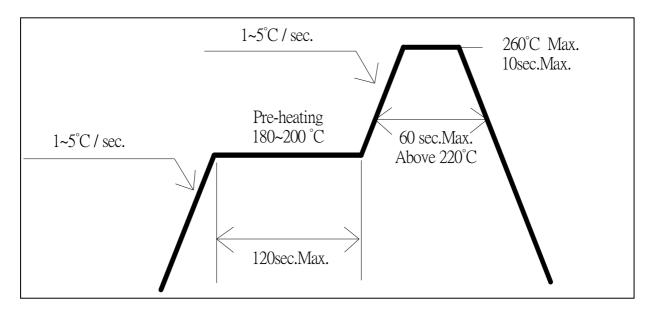
OSTCXBSEC1E

VER A.1

■ Soldering Conditions

Reflow Soldering		Hand Soldering		
Pre-Heat	180 ~ 200°C			
Pre-Heat Time	120 sec. Max.		350°C Max.	
Peak temperature	260°C Max.	Temperature	3 sec. Max.	
Dipping Time	10 sec. Max.	Soldering time	(one time only)	
Condition	Refer to Temperature-profile		(one time only)	

• Reflow Soldering Condition(Lead-free Solder)



- *Recommended soldering conditions vary according to the type of LED
- *Although the recommended soldering conditions are specified in the above table, reflow, or hand soldering at the lowest possible temperature is desirable for the LEDs.
- *A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- •All SMD LED products are pb-free soldering available.
- Occasionally there is a brightness decrease caused by the influence of heat or ambient atmosphere during air reflow. It is recommended that the User use the nitrogen reflow method.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.









LED & Application Technologies

http://www.optosupply.com VER A.1